

## Plastic-Encapsulate Diodes

Low leakage switching diode

### Features

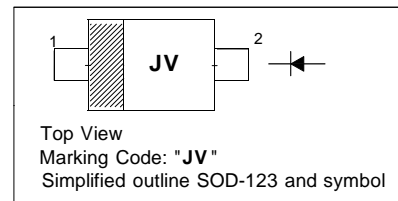
- Plastic SMD package
- Low leakage current

### Application

- Low leakage current applications in surface mounted circuits.

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



### MARKING: JV

### Absolute Maximum Ratings ( $T_a = 25\text{ °C}$ )

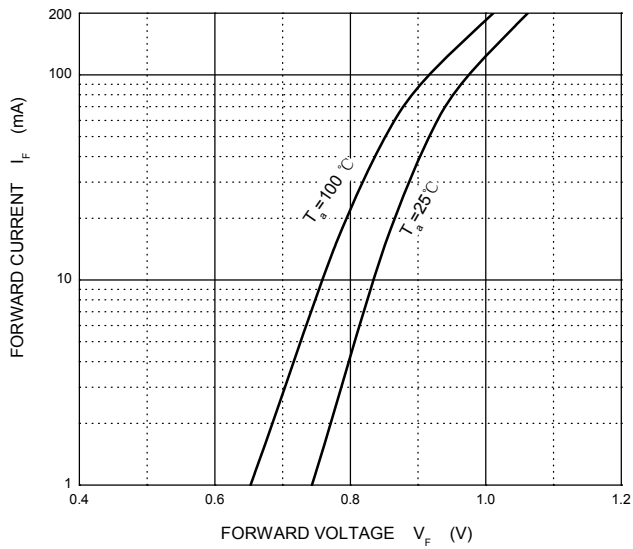
Parameter	Symbol	Value	Unit	
Repetitive Peak Reverse Voltage	$V_{RRM}$	85	V	
Continuous Reverse Voltage	$V_R$	75	V	
Continuous Forward Current	$I_F$	200	mA	
Repetitive Peak Forward Current	$I_{FRM}$	500	mA	
Non-Repetitive Peak Forward Surge Current	$I_{FSM}$	$t = 1\ \mu\text{s}$	4	A
		$t = 1\ \text{ms}$	1	
		$t = 1\ \text{s}$	0.5	
Power Dissipation	$P_{tot}$	350	mW	
Junction Temperature	$T_j$	150	°C	
Storage Temperature Range	$T_{stg}$	- 65 to + 150	°C	

### Characteristics at $T_a = 25\text{ °C}$

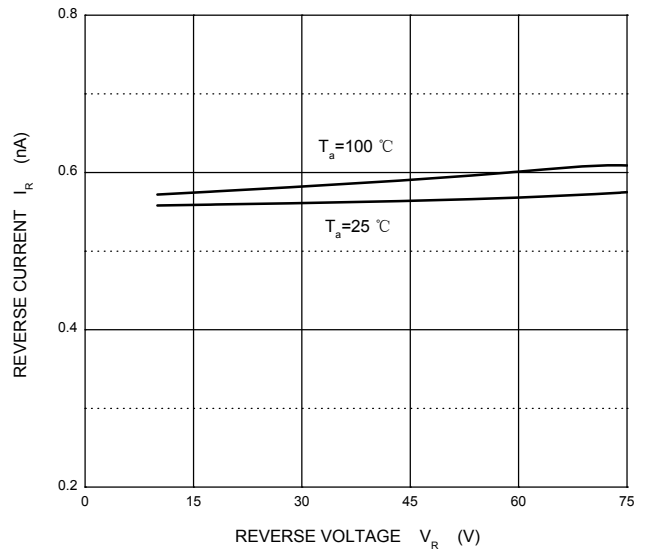
Parameter	Symbol	Typ.	Max.	Unit	
Forward Voltage	$V_F$	-	at $I_F = 1\ \text{mA}$	0.9	V
			at $I_F = 10\ \text{mA}$	1	V
			at $I_F = 50\ \text{mA}$	1.1	V
			at $I_F = 150\ \text{mA}$	1.25	V
Reverse Current	$I_R$	-	at $V_R = 75\ \text{V}$	5	nA
			at $V_R = 75\ \text{V}, T_j = 150\text{ °C}$	80	
Diode Capacitance	$C_d$	2	-	pF	
Reverse Recovery Time	$t_{rr}$	-	3	$\mu\text{s}$	
at $I_F = I_R = 10\ \text{mA}, R_L = 100\ \Omega, i_{rr} = 0.1\ I_R$					

## Typical Characteristics

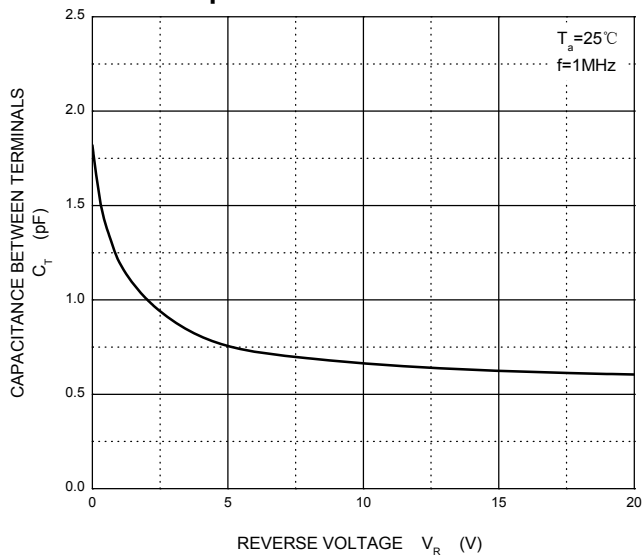
**Forward Characteristics**



**Reverse Characteristics**



**Capacitance Characteristics**



**Power Derating Curve**

